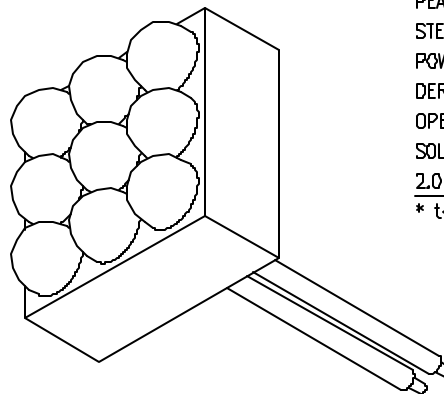
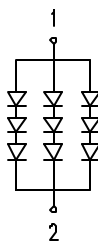


PIN OUT



ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^{\circ}\text{C}$

PARAMETER	SYMBOL	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH			550		nm	
FORWARD VOLTAGE	$V_f$		10.5	12.0	V	$I_f=80\text{mA}$
REVERSE VOLTAGE	$V_r$	5.0			V	$I_f=10\mu\text{A}$
AXIAL INTENSITY**	$I_v$		2000		mcd	$I_f=80\text{mA}$
CHROMATICITY COORDINATES***	X	0.28	0.31	0.34		$I_f=60\text{mA}$
	Y	0.29	0.32	0.35		
VIEWING ANGLE			30		2x theta	
EMITTED COLOR:					WHITE	
EPOXY LENS FINISH:					WATER CLEAR	

\*\* INTENSITY PER DIE.

AXIAL INTENSITY TESTING CONDITION: 550nm WAVELENGTH.

\*\*\* CHROMATICITY COORDINATES PER THE ICI STANDARD COLORIMETRIC SYSTEM.

LIMITS OF SAFE OPERATION AT 25°C PER DIE

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	100	mA
STEADY CURRENT	98	mA
POWER DISSIPATION	30	mW
DERATE FROM 25°C	-1.0	mW/°C
OPERATING, STORAGE TEMP.	-30 TO +70	°C
SOLDERING TEMP.	+260	°C
2.0mm FROM BODY		3 SEC. MAX

\*  $t < 10\mu\text{s}$

CAUTION: STATIC SENSITIVE DEVICE  
FOLLOW PROPER E.S.D. HANDLING PROCEDURES  
WHEN WORKING WITH THIS PART.  
ESD CLASSIFICATION: CLASS II BASED ON MIL-STD 883E.

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030), MIN.=<sup>+0.00</sup>/<sub>-0.00</sub> MAX.=<sup>+0.00</sup>/<sub>-0.00</sub>

REV.

PART NUMBER  
SSP-LXS06799

CONFIDENTIAL INFORMATION  
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0.67" SQUARE, 9 LAMP POLYLED, COMMON ANODE,  
550nm InGaN/SiC WHITE LEADS, WATER CLEAR LENS.

RELIABILITY NOTE  
OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN: BC	CHECKED:	APPROVED:	DATE: 4.28.00 PAGE: 1 OF 1
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